



Application No. 09/461,158  
Amendment. dated December 19, 2003  
Reply to Office Action of September 25, 2003

RECEIVED  
DEC 31 2003  
TC 1700

Attorney's Docket No.: 42390.P6958

Patent

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:

Anne E. Miller et al.

U.S. Serial No: 09/461,158

Examiner: Chen, Kin Chan

Filed: December 14, 1999

Art Unit: 1765

For: HIGH PH SLURRY FOR  
CHEMICAL MECHANICAL  
POLISHING OF COPPER

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT AND RESPONSE**

Dear Sir:

This is in response to the Office Action mailed September 25, 2003. Applicant respectfully requests the Examiner to consider the following remarks.

**FIRST CLASS CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

on December 19, 2003  
Date of Deposit

Claire Wallters  
Name of Person Mailing Correspondence

Claire Wallters  
Signature

12/19/2003  
Date